



# CEP840B/CEB840B

## N-Channel Enhancement Mode Field Effect Transistor

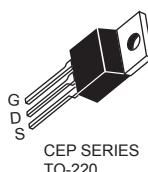
PRELIMINARY

### FEATURES

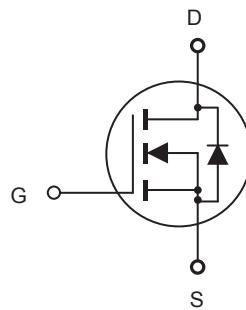
- 440V, 9A,  $R_{DS(ON)} = 0.76\Omega$  @  $V_{GS} = 10V$ .
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handing capability.
- Lead free product is acquired.
- TO-220 & TO-263 package.



CEB SERIES  
TO-263(DD-PAK)



CEP SERIES  
TO-220



### ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ C$ unless otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	$V_{DS}$	440	V
Gate-Source Voltage	$V_{GS}$	$\pm 30$	V
Drain Current-Continuous	$I_D$	9	A
Drain Current-Pulsed <sup>a</sup>	$I_{DM}$	36	A
Maximum Power Dissipation @ $T_C = 25^\circ C$ - Derate above $25^\circ C$	$P_D$	125 0.83	W W/ $^\circ C$
Operating and Store Temperature Range	$T_J, T_{stg}$	-55 to 155	$^\circ C$

### Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case	$R_{JC}$	1.0	$^\circ C/W$
Thermal Resistance, Junction-to-Ambient	$R_{JA}$	62.5	$^\circ C/W$

This is preliminary information on a new product in development now .  
Details are subject to change without notice .

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## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

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Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	440			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 440\text{V}, V_{\text{GS}} = 0\text{V}$			100	$\mu\text{A}$
Gate Body Leakage Current, Forward	$I_{\text{GSSF}}$	$V_{\text{GS}} = 30\text{V}, V_{\text{DS}} = 0\text{V}$			100	nA
Gate Body Leakage Current, Reverse	$I_{\text{GSSR}}$	$V_{\text{GS}} = -30\text{V}, V_{\text{DS}} = 0\text{V}$			-100	nA
<b>On Characteristics<sup>b</sup></b>						
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{GS}} = V_{\text{DS}}, I_D = 250\mu\text{A}$	2		4	V
Static Drain-Source On-Resistance	$R_{\text{DS(on)}}$	$V_{\text{GS}} = 10\text{V}, I_D = 4\text{A}$		0.65	0.76	$\Omega$
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}} = 10\text{V}, I_D = 4\text{A}$		6		S
<b>Dynamic Characteristics<sup>c</sup></b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		1400		pF
Output Capacitance	$C_{\text{oss}}$			330		pF
Reverse Transfer Capacitance	$C_{\text{rss}}$			120		pF
<b>Switching Characteristics<sup>c</sup></b>						
Turn-On Delay Time	$t_{\text{d(on)}}$	$V_{\text{DD}} = 200\text{V}, I_D = 9\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 9.1\Omega$		21		ns
Turn-On Rise Time	$t_r$			86		ns
Turn-Off Delay Time	$t_{\text{d(off)}}$			97		ns
Turn-Off Fall Time	$t_f$			78		ns
Total Gate Charge	$Q_g$	$V_{\text{DS}} = 320\text{V}, I_D = 9\text{A}, V_{\text{GS}} = 10\text{V}$		48	65	nC
Gate-Source Charge	$Q_{\text{gs}}$			4		nC
Gate-Drain Charge	$Q_{\text{gd}}$			15		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Drain-Source Diode Forward Current	$I_S$				9	A
Drain-Source Diode Forward Voltage <sup>b</sup>	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_S = 9\text{A}$			1.5	V

Notes :

- a.Repetitive Rating : Pulse width limited by maximum junction temperature .
- b.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$  .
- c.Guaranteed by design, not subject to production testing.



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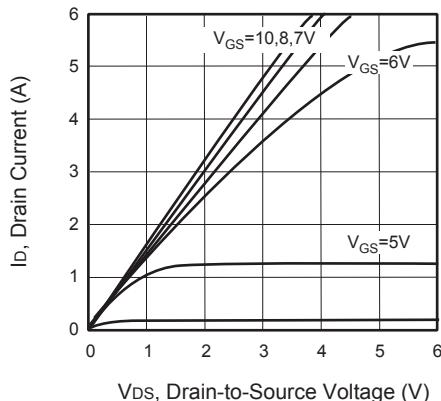


Figure 1. Output Characteristics

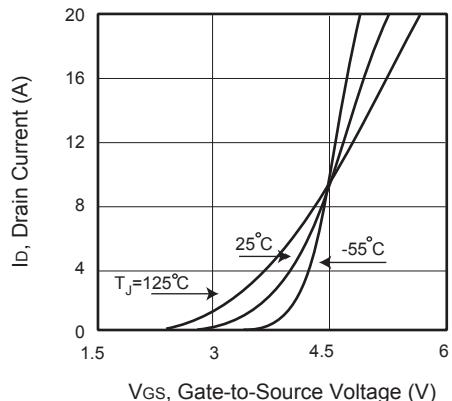


Figure 2. Transfer Characteristics

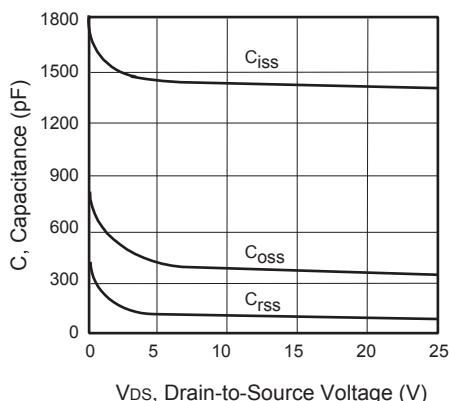


Figure 3. Capacitance

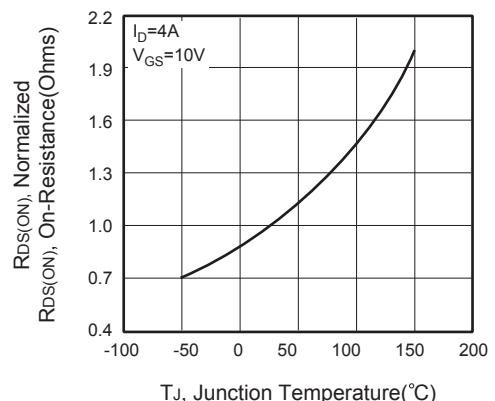


Figure 4. On-Resistance Variation with Temperature

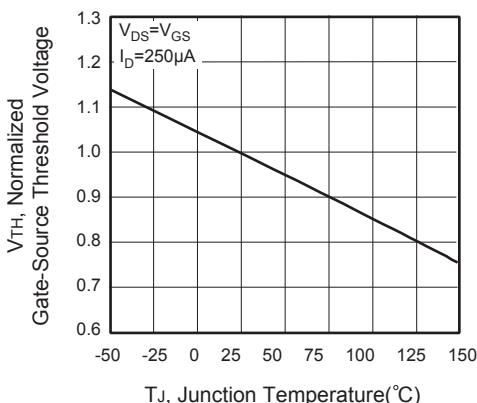


Figure 5. Gate Threshold Variation with Temperature

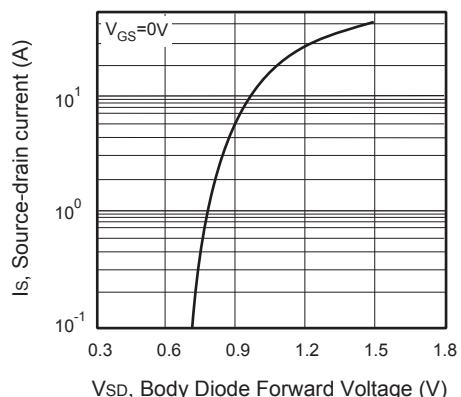
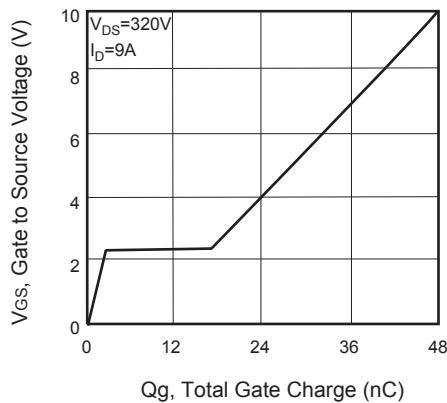
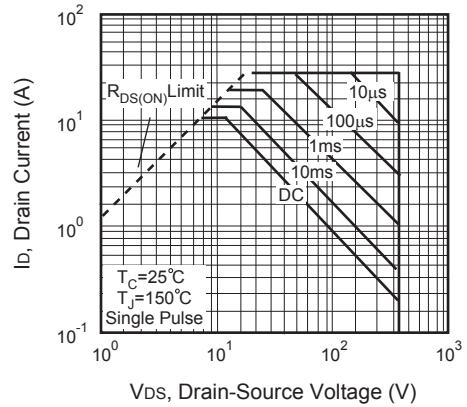


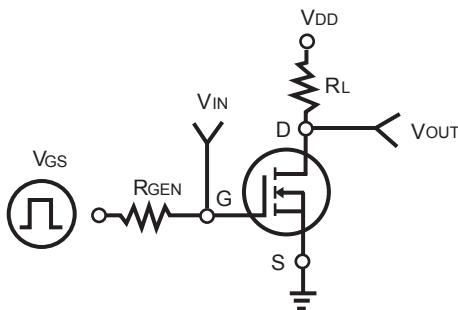
Figure 6. Body Diode Forward Voltage Variation with Source Current



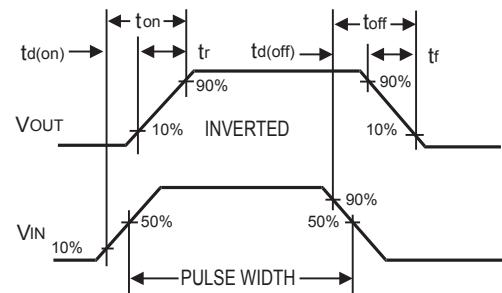
**Figure 7. Gate Charge**



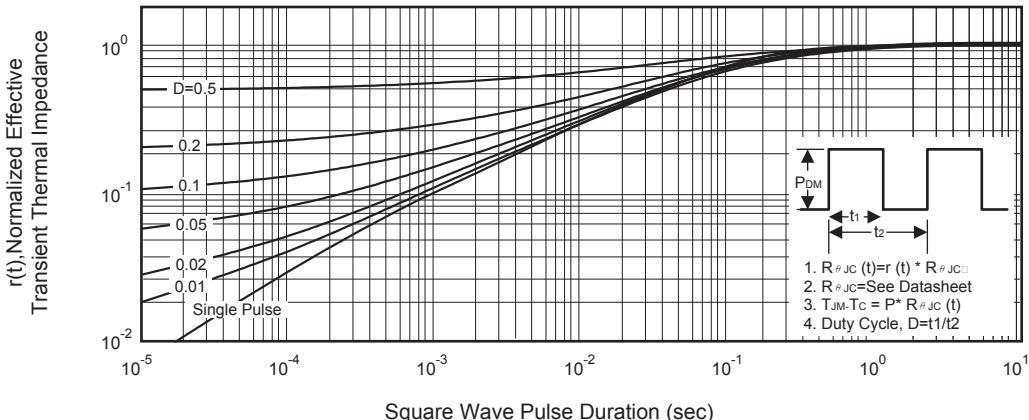
**Figure 8. Maximum Safe Operating Area**



**Figure 9. Switching Test Circuit**



**Figure 10. Switching Waveforms**



**Figure 11. Normalized Thermal Transient Impedance Curve**